

Environmental Specifications

ENV21

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

| Specification | Test/Inspection Condition | Reference/Spec |
|--------------------------------|--|---|
| Operating Temperature | -40° to 85°C Ambient Environment | Individual Model Data Sheet |
| Storage Temperature | -55° to 100° C Ambient Environment | Individual Model Data Sheet |
| Thermal Shock | -55° to 100°C, 100 cycles | MIL-STD-202, Method 107, Condition A-3, except +100°C |
| Solder Reflow Heat | Sn-Pb Eutectic Process: 225°C peak Pb-Free Process, 245°C peak | J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1 |
| Solderability | 10X Magnification | J-STD-002, Para 4.2.5, Test S, 95% Coverage |
| Vibration (High Frequency) | 20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36) | MIL-STD-202, Method 204, Condition D |
| Mechanical Shock | 50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes | MIL-STD-202, Method 213, Condition A |
| Lead Integrity | 2 Pound Pull, perpendicular to edge of unit | MIL-STD-202, Method 211, Condition A |
| Marking Resistance to Solvents | Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C | MIL-STD-202, Method 215 |

ENV21 Rev: A

03/10/11

M131005 File: ENV21.pdf

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